

Smart Highside Power Switch

Reversave™

• Reverse battery protection by self turn on of power MOSFET

Features

- Short circuit protection with latch
- Current limitation
- Overload protection
- Thermal shutdown with restart
- Overvoltage protection (including load dump)
- Loss of ground protection
- Loss of V_{bb} protection (with external diode for charged inductive loads)
- Very low standby current
- Fast demagnetization of inductive loads
- Electrostatic discharge (ESD) protection
- Optimized static electromagnetic compatibility (EMC)

Diagnostic Function

Product Summary Operating voltage 5.5...38 V Vbb(on) On-state resistance RON 9 $m\Omega$ Nominal current IL(nom) 9.5 А А Load current (ISO) IL(ISO) 37.5 **Current limitation** А *I*L12(SC) 90

Package



• Proportional load current sense (with defined fault signal in case of overload operation, overtemperature shutdown and/or short circuit shutdown)

Application

- Power switch with current sense diagnostic feedback for 12V and 24 V DC grounded loads
- All types of resistive, inductive and capacitive loads
- Replaces electromechanical relays, fuses and discrete circuits

General Description

N channel vertical power FET with charge pump, current controlled input and diagnostic feedback with load current sense, integrated in Smart SIPMOS[®] chip on chip technology. Providing embedded protective functions.





| Pin | Symbol | | Function |
|--------|--------|---|---|
| 1; 2 | OUT | 0 | Output; output to the load; pin 1, 2, 6 and 7 must be externally shorted* . |
| 3 | IN | I | Input; activates the power switch if shorted to ground. |
| 4; Tab | Vbb | + | Supply Voltage; positive power supply voltage; tab and pin4 are internally shorted. |
| 5 | IS | S | Sense Output ; Diagnostic feedback; provides at normal operation a sense current proportional to the load current; in case of overload, overtemperature and/or short circuit a defined current is provided (see Truth Table on page 8) |
| 6; 7 | OUT | 0 | Output; output to the load; pin 1, 2, 6 and 7 must be externally shorted* . |

*) Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability and decrease the current sense accuracy

| Maximum Ratings | at T _j = 25 °C unless | otherwise specified |
|-----------------|----------------------------------|---------------------|
|-----------------|----------------------------------|---------------------|

| Parameter | Symbol | Values | Unit |
|--|--|--------------------|------|
| Supply voltage (overvoltage protection see page 4) | V _{bb} | 38 | V |
| Supply voltage for full short circuit protection ¹⁾ | V _{bb} | 30 | V |
| Load dump protection $V_{\text{LoadDump}} = U_A + V_s$, $U_A = 13.5 \text{ V}$ $R_I = 2 \Omega$, $R_L = 1\Omega$, $t_d = 400 \text{ ms}$, IN= low or high | V _{Load dump²⁾} | 45 | V |
| Load current (Short-circuit current, see page 5) | IL. | self-limited | A |
| Operating temperature range | T _j | -40+150 | °C |
| Storage temperature range | T _{stg} | -55+150 | |
| Power dissipation (DC) | P _{tot} | 81 | W |
| Inductive load switch-off energy dissipation $m^{3)}$ single pulse, $I_{L} = 20 \text{ A}$, $V_{bb} = 12 \text{ V}$ $T_{j} = 150 \text{ °C}$: | E _{AS} | 0.4 | J |
| Electrostatic discharge capability (ESD) (Human Body Model) acc. ESD assn. std. S5.1-1993; R=1.5kΩ; C=100pF | V _{ESD} | 3.0 | kV |
| Current through input pin (DC) | / _{IN} | +15, -120 | mA |
| Current through current sense pin (DC) | l _{IS} | +15, -120 | |
| see internal circuit diagrams page 9 | | | |
| Input voltage slew rate | | | |
| $V_{ m bb} \le 16V$: $V_{ m bb} > 16V^{-4}$: | $\mathrm{d}V_{\mathrm{bIN}}/\mathrm{d}t$ | self-limited 20 | V/µs |

Short circuit is defined as a combination of remaining resistances and inductances. See schematic on page11.

²⁾ V_{Load dump} is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

³⁾ See also diagram on page 11.

⁴⁾ See also on page 8. Slew rate limitation can be achieved by means of using a series resistor R_{IN} in the input path. This resistor is also required for reverse operation. See also page 10.



Thermal Characteristics

| Parameter and Conditions | | Symbol | Values | | | Unit |
|--------------------------|--|---------------------------------|--------|-----|-----|------|
| | | - | min | typ | max | |
| Thermal resistance | chip - case: | R _{thJC} ⁵⁾ | | 0.7 | 0.8 | K/W |
| | | $R_{ m thJA}$ | | 60 | | |
| SMD | version, device on PCB ⁶⁾ : | | | 33 | 40 | |

Electrical Characteristics

| Parameter and Conditions | Symbol | Values | | Unit | |
|---|--------|--------|-----|------|--|
| at T_{j} = 25, V_{bb} = 12 V unless otherwise specified | | min | typ | max | |

Load Switching Capabilities and Characteristics

| 0 1 | | | | | | |
|---|-------------------------------|-----------------------|------|-----|------|------|
| On-state resistance (pin 3 to pin 1, | ,2,6,7) | | | | | |
| $V_{\rm IN}$ = 0, $V_{\rm bb}$ = 5.5V, $I_{\rm L}$ = 10 A | <i>T</i> j=25 °C: | R _{ON} | | 9.5 | 13 | mΩ |
| | <i>T</i> j=150 °C: | | | 17 | 22 | |
| $V_{\rm IN}$ = 0, $V_{\rm bb}$ = 12V, $I_{\rm L}$ = 10 A | <i>T</i> j=25 °C: | | | 7 | 9 | |
| | <i>T</i> j=150 °C: | | | 13 | 16 | |
| Output voltage drop limitation at sr currents (Tab to pin 1,2,6,7) | | V _{ON(NL)} | | 30 | 60 | mV |
| Nominal load current (Tab to pin 1,5) | | | | | | |
| ISO Proposal: $V_{ON} \le 0.5 \text{ V}$, $T_C = 85^{\circ}\text{C}$, $T_i \le 150^{\circ}\text{C}$ | | I _{L(ISO)} | 37.5 | 48 | | А |
| SMD ⁶⁾ , $V_{ON} \le 0.5$ V, $T_{A} = 85^{\circ}C$, | <i>T</i> _j ≤ 150°C | I _{L(nom)} | 9.5 | 12 | | |
| Turn-on time | to 90% V _{OUT} : | <i>t</i> on | | 300 | 550 | μs |
| Turn-off time | to 10% V _{OUT} : | <i>t</i> off | | 300 | 600 | |
| <i>R</i> _L = 2.2 Ω, <i>T</i> _j =-40150 °C | | | | | | |
| Slew rate on | | dV/dt _{on} | | 0.2 | 0.35 | V/µs |
| 25 to 50% V_{OUT} , R_{L} = 2.2 Ω , T_{j} =-40150 °C | | | | | | |
| Slew rate off 50 to 25% V_{OUT} , $R_L = 2.2 \Omega$, $T_{i}=-4$ | 0150 °C | -dV/dt _{off} | | 0.2 | 0.45 | V/µs |
| | | | 1 | | | |

⁵⁾ Thermal resistance R_{thCH} case to heatsink (about 0.5 ... 0.9 K/W with silicone paste) not included!

⁶⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for V_{bb} connection. PCB is vertical without blown air.

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| Parameter and Conditions | Symbol | Values | | | Unit |
|---|--------|--------|-----|-----|------|
| at T_{j} = 25, V_{bb} = 12 V unless otherwise specified | | min | typ | max | |

Operating Parameters

| Operating voltage (VIN=0) | <i>T</i> _j =-40150 °C: | V _{bb(on)} | 5.5 | | 38 | V |
|--|-----------------------------------|----------------------|-----|-----|-----|----|
| Undervoltage shutdown ^{7) 8)} | | V _{bIN(u)} | | 2.5 | 3.5 | V |
| Undervoltage restart of charge pump | | V _{bb(ucp)} | | 4 | 5.5 | V |
| Overvoltage protection ⁹⁾ | | V _{Z,IN} | 63 | 67 | | V |
| <i>I</i> _{bb} =15 mA | <i>T</i> _j =-40+150°C: | | | | | |
| Standby current | <i>T</i> _j =-40+120°C: | I _{bb(off)} | | 3 | 6 | μA |
| / _{IN} =0 | <i>T</i> j=150°C: | | | 6 | 14 | |

Reverse Battery

| Reverse battery voltage ¹⁰⁾ | -V _{bb} | | 16 | V |
|---|----------------------|---------------|----------|----|
| On-state resistance (pin 4, Tab to pin 1,2,6,7) | | | | |
| V_{bb} = -8V, V_{IN} = 0, I_{L} = -10 A, R_{IS} = 1 k Ω , ⁸⁾ T_{j} =25 °C: T_{i} =150 °C: | R _{ON(rev)} | 8.5 13 | 12 18 | mΩ |
| V_{bb} = -12V, V_{IN} = 0, I_{L} = -10 A, R_{IS} = 1 kΩ, T_{j} =25 °C: T_{j} =150 °C: | | 8 13 | 11 19 | |
| Integrated resistor in V _{bb} line | R _{bb} | 100 | 150 | Ω |

Inverse Operation 11)

| Output voltage drop (pin 4, Tab to pin 1,2,6 | ,7) ⁸⁾ | | | |
|--|-------------------|---------|---------|--------|
| | | ON(inv) | 700 | mV |
| $I_{\rm L} = -10 \text{ A}, R_{\rm IS} = 1 \text{ k}\Omega, \qquad T_{\rm j} =$ | 150 °C: | | 300 | |
| Turn-on delay after inverse operation; $I_L > 0A^{8}$ $V_{IN}(inv) = V_{IN}(fwd) = 0 V$ | | (inv) | 1 | ms |
| | - 0(| (IIIV) | 1 | |

⁷⁾ VbIN=Vbb-VIN see diagram page 14.

⁸⁾ not subject to production test, specified by design

⁹⁾ See also $V_{ON(CL)}$ in circuit diagram page 9.

¹⁰⁾ For operation at voltages higher then |16V| please see required schematic on page 10.

¹¹⁾ Permanent Inverse operation results eventually in a current flow via the intrinsic diode of the power DMOS.

In this case the device switches on with a time delay $t_{d(inv)}$ after the transition from inverse to forward mode.



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| Parameter and Conditions | | Symbol | | Unit | | |
|---|---|-----------------------------|------------|-------------------|-------------|----|
| at T_{j} = 25, V_{bb} = 12 V unless otherwise specifi | ed | | min | typ | max | |
| Protection Functions ¹²⁾ | | • | | | | |
| Short circuit current limit (pin 4, Tab to pin 1,2,6,7) ¹³⁾ | 0 | | | | | |
| Short circuit current limit at $V_{ON} = 6V^{14}$ | <i>T</i> _j =-40°C: <i>T</i> _j =25°C: <i>T</i> _j =+150°C: | I _{L6(SC)} | 90 | 140 130 120 | 170 | A |
| Short circuit current limit at $V_{ON} = 12V$ $t_m = 170 \mu s$ | <i>T</i> _j =-40°C: <i>T</i> _j =25°C: <i>T</i> _j =+150°C: | I _{L12(SC)} | 55 | 105 95 85 | 130 | A |
| Short circuit current limit at V_{ON} = 18V ¹⁴) | <i>T</i> j =-40°C: <i>T</i> j =25°C: <i>T</i> j =+150°C: | <i>I</i> _{L18(SC)} | 45 | 75 70 65 | 100 | A |
| Short circuit current limit at $V_{ON} = 24V$ $t_m = 170 \mu s$ | <i>T</i> j =-40°C: <i>T</i> j =25°C: <i>T</i> j =+150°C: | <i>I</i> _{L24(SC)} | 28 | 47 46 45 | 70 | A |
| Short circuit current limit at $V_{\rm ON}$ = 36V ¹⁴⁾ | <i>T</i> j =-40°C: <i>T</i> j =25°C: <i>T</i> j =+150°C: | <i>I</i> _{L36(SC)} | 15 | 27 27 27 | 40 | A |
| Short circuit shutdown detection volta | ige | V _{ON(SC)} | 2.5 | 3.5 | 4.5 | V |
| Short circuit shutdown delay after inp positive slope, $V_{ON} > V_{ON(SC)}$, $T_j = -40$ min. value valid only if input "off-signal" time e | .+150°C | $t_{d(SC1)}$ | 350 | 650 | 1200 | μs |
| Short circuit shutdown delay during o $V_{\rm ON} > V_{\rm ON(SC)}$ | n condition ¹⁴⁾ | t _{d(SC2)} | | 2 | | μs |
| Output clamp (inductive load switch of at $V_{OUT} = V_{bb} - V_{ON(CL)}$ (e.g. overvolta) $I_{L} = 40 \text{ mA}$ | off) ¹⁵⁾ age) | V _{ON(CL)} | 39 | 42 | | V |
| Thermal overload trip temperature | | <i>T</i> _{jt} | 150 | 175 | | °C |
| Thermal hysteresis | | ΔT_{jt} | | 10 | | K |

¹²⁾ Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

¹³⁾ Short circuit current limit for max. duration of $t_{d(SC1)}$, prior to shutdown, see also figures 3.x on page 13.

¹⁴⁾ not subject to production test, specified by design

¹⁵⁾ See also figure 2b on page 12.



| Parameter and Conditions | Symbol | Values | | Unit | |
|---|--------|--------|-----|------|--|
| at $T_{\rm j}$ = 25, $V_{\rm bb}$ = 12 V unless otherwise specified | | min | typ | max | |

Diagnostic Characteristics

| Diagnostic Characteristics | | | | | | |
|--|------------------------------------|--------------------------|----------------|----------------|----------------|------------|
| Current sense ratio, static on-co | ndition | <i>k</i> _{ILIS} | | 12500 | | |
| $k_{\text{ILIS}} = I_{\text{L}} : I_{\text{IS}}, I_{\text{IS}} < I_{\text{IS,lim}} {}^{16)}, V_{\text{IS}} < V_{\text{OUT}} - 5 \text{V}, V_{\text{bIN}} > 4.5 \text{V}$ | | | | | | |
| IL | = 35A, Tj = -40°C: | | 11200 | 12700 | 14000 | |
| | Tj = +25°C: Tj = +150°C: | | 11000 11000 | 12600 12200 | 13500 12800 | |
| IL | $= 10A, Tj = -40^{\circ}C:$ | | | 12700 | 14300 | |
| | Tj = +25°C: Tj = +150°C: | | 10500 10800 | 12600 12200 | 14000 13300 | |
| IL : | = 2.5A, Tj = -40°C: | | 10000 | 12300 | 17000 | |
| | Tj = +25°C: Tj = +150°C: | | 10000 10000 | 12500 13000 | 16500 15000 | |
| IL : | $= 0.5A, Tj = -40^{\circ}C:$ | | 7000 | 14000 | 26000 | |
| | Tj = +25°C: Tj = +150°C: | | 8000 9000 | | 24500 23000 | |
| $I_{\rm IN} = 0$ (e.g. during deenergizing of inductive loads): | | | | 0 | | |
| Sense current under fault condit | ions ¹⁷⁾ | | | | | |
| V _{ON} >1V, typ | <i>T</i> _j = -40+150°C: | I _{IS,fault} | 4.0 | 5.2 | 7.5 | mA |
| Sense saturation current | T 40 45000 | | | | | |
| V _{ON} <1V, typ | $T_{j} = -40+150^{\circ}C:$ | <i>I</i> IS,lim | 4.0 | 6.0 | 7.5 | mA |
| Fault-Sense signal delay after input current positive slope, V _{ON} >1V, <i>T</i> j = -40+150°C | | <i>t</i> delay(fault) | 350 | 650 | 1200 | μs |
| Current sense leakage current, $I_{IN} = 0$ | | I _{IS(LL)} | | 0.1 | 0.5 | μA |
| Current sense offset current, $V_{IN} = 0$, $I_L \le 0$ | | I _{IS(LH)} | | 0.1 | 1 | μA |
| Minimum load current for sense functionality, | | I _{L(MIN)} | 50 | | | mA |
| $V_{\rm IN} = 0, \ T_{\rm j} = -40+150^{\circ}{\rm C}$ | | | | | | |
| Current sense settling time to $I_{IS \text{ static}}$ after input current positive slope, ¹⁸⁾ $I_L = 0 - 20 \text{ A}, T_i = -40+150^{\circ}\text{C}$ | | t _{son(IS)} | | 250 | 500 | μs |
| Current sense settling time during on condition, ¹⁸⁾ | | | | | | |
| <i>I</i> _L = 10 20 A, <i>T</i> _j = -40+150°C | | $t_{\rm SIC(IS)}$ | | 50 | 100 | μs |
| Overvoltage protection | | | | | | . <i>.</i> |
| $I_{bb} = 15 \mathrm{mA}$ | <i>T</i> _j = -40+150°C: | V _{Z,IS} | 63 | 67 | | V |

¹⁶⁾ See also figures 4.x and 6.x on page 13 and 14.

¹⁷⁾ Fault conditions are overload during on (i.e. V_{ON}>1V typ.), overtemperature and short circuit; see also truth table on page 8.

¹⁸⁾ not subject to production test, specified by design



| Parameter and Conditions | Symbol | | Values | ; | Unit |
|---|--------|-----|--------|-----|------|
| at T_{j} = 25, V_{bb} = 12 V unless otherwise specified | | min | typ | max | |

Input

| Required current capability of input switch $T_j = -40+150^{\circ}C$: | | I _{IN(on)} | 1.4 | 2.2 | mA |
|--|-----------------------------------|----------------------|---------|-----|----|
| Input current for turn-off | <i>T</i> _j =-40+150°C: | I _{IN(off)} | | 30 | μA |



Truth Table

| | Input Current | Output | Current Sense |
|-------------------------------------|------------------|--------|--|
| | level | level | lis |
| Normal | L | L | ≈0 (/ IS(LL)) |
| operation | Н | н | nominal |
| Overload ¹⁹⁾ | L | L | ≈0 (/ IS(LL)) |
| | Н | н | I _{IS,fault} |
| Short circuit to GND ²⁰⁾ | L | L | ≈0 (/ IS(LL)) |
| | н | L | I _{IS,fault} |
| Overtemperature | L | L | ≈0 (/ IS(LL)) |
| | н | L | I _{IS,fault} |
| Short circuit to Vbb | L | Н | ≈0 (/ IS(LL)) |
| | Н | Н | <nominal<sup>21)</nominal<sup> |
| Open load | L | Z | ≈0 (/ IS(LL)) |
| | н | н | ≈0 (/ _{IS(LL)}) ≈0 (/ _{IS(LH)}) |

L = "Low" Level H = "High" Level Z = high impedance, potential depends on external circuit

Terms



Two or more devices can easily be connected in parallel to increase load current capability.

¹⁹⁾ Overload is detected at the following condition: 1V (typ.) < $V_{_{\rm ON}}$ < 3.5V (typ.) . See also page 11.

²⁰⁾ Short Circuit is detected at the following condition: $V_{oN} > 3.5V$ (typ.) . See also page 11. ²¹⁾ Low ohmic short to V_{bb} may reduce the output current I_L and therefore also the sense current I_{IS} .



Input circuit (ESD protection)



ESD-Zener diode: 67 V typ., max 15 mA;

Current sense output

Normal operation



 $V_{Z,IS} = 67 V$ (typ.), $R_{IS} = 1 k\Omega$ nominal (or $1 k\Omega /n$, if n devices are connected in parallel). $I_S = I_L / k_{ilis}$ can be only driven by the internal circuit as long as $V_{out} - V_{IS} > 5V$. Therefore R_{IS} should be less than

$$\frac{V_{bb} - 5V}{7.5mA}$$

Note: For large values of R_{IS} the voltage V_{IS} can reach almost V_{bb} . See also overvoltage protection. If you don't use the current sense output in your application, you can leave it open.

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Inductive and overvoltage output clamp



VON is clamped to VON(CI) = 42V typ

Overvoltage protection of logic part



 $\label{eq:Rbb} \begin{array}{l} R_{bb} = 100\,\Omega\,typ., \ V_{Z,IN} = V_{Z,IS} = 67\,V\,typ., \ R_{IS} = 1\,k\Omega\\ nominal. \ Note that when overvoltage exceeds 67\,V\,typ.\\ a \,voltage \ above \,5V\ can \ occur \ between \,IS \ and \,GND, \ if \ R_V, \ V_{Z,VIS} \ are \ not \ used. \end{array}$



Reversave™ (Reverse battery protection)



 R_{IS} typ. 1 k Ω . Add R_{IN} for reverse battery protection in applications with V_{bb} above 16V;

recommended value: $\frac{1}{R_{\rm IN}} + \frac{1}{R_{\rm IS}} = \frac{0.08A}{\mid V_{bb}\mid -12V}$

To minimise power dissipation at reverse battery operation, the overall current into the IN and IS pin should be about 80mA. The current can be provided by using a small signal diode D in parallel to the input switch, by using a MOSFET input switch or by proper adjusting the current through $R_{\rm IS}$.

Since the current via R_{bb} generates additional heat in the device, this has to be taken into account in the overall thermal consideration.

Inverse load current operation



The device can be operated in inverse load current mode ($V_{OUT} > V_{bb} > 0V$). The current sense feature is not available during this kind of operation ($I_{IS} = 0$). In case of inverse operation the intrinsic drain source diode is eventually conducting resulting in considerably increased power dissipation.

The transition from inverse to forward mode can result in a delayed switch on.

Note: Temperature protection during inverse load current operation is not possible!

V_{bb} disconnect with energised inductive load

Provide a current path with load current capability by using a diode, a Z-diode, or a varistor. ($V_{ZL}+V_D$ <39 V if $R_{IN} = 0$). For higher clamp voltages currents at IN and IS have to be limited to 120 mA.

Version a:





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Short circuit detection

Fault Condition: V_{ON} > $V_{ON(SC)}$ (3.5 V typ.) and t> $t_{d(SC)}$ (typ.650 µs).

Overload detection

Fault Condition: $V_{ON} > 1 V$ typ.



Short circuit

Short circuit is a combination of primary and secondary impedance's and a resistance's.



Allowable combinations of minimum, secondary resistance for full protection at given secondary inductance and supply voltage for single short circuit event:



Inductive load switch-off energy dissipation



Energy stored in load inductance:

$$E_{\rm L} = \frac{1}{2} \cdot {\rm L} \cdot {\rm I}_{\rm L}^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

 $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} \cdot i_L(t) dt,$

with an approximate solution for $R_L > 0 \Omega$:

$$E_{\text{AS}} = \frac{I_{\text{L}} \cdot L}{2 \cdot R_{\text{L}}} (V_{\text{bb}} + |V_{\text{OUT}(\text{CL})}|) ln (1 + \frac{I_{\text{L}} \cdot R_{\text{L}}}{|V_{\text{OUT}(\text{CL})}|})$$

Maximum allowable load inductance for a single switch off

 $L = f(I_L)$; T_{j,start} = 150°C, V_{bb} = 12 V, R_L = 0 Ω





Timing diagrams

Figure 1a: Switching a resistive load, change of load current in on-condition:



The sense signal is not valid during a settling time after turn-on/off and after change of load current.

Figure 2a: Switching motors and lamps:



As long as $V_{bIS} < V_{Z,IS}$ the sense current will never exceed $I_{IS,fault}$ and/or $I_{IS,lim}$.

Figure 2b: Switching an inductive load:





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Figure 3a: Typ. current limitation characteristic



In case of $V_{ON} > V_{ON(SC)}$ (typ. 3.5 V) the device will be switched off by internal short circuit detection.

Figure 3b: Short circuit type one:

shut down by short circuit detection, reset by $I_{IN} = 0$.



Shut down remains latched until next reset via input.

Figure 3c: Short circuit type two:

shut down by short circuit detection, reset by $I_{IN} = 0$.





Figure 4a: Overtemperature Reset if $T_i < T_{jt}$





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Figure 5a: Undervoltage restart of charge pump, overvoltage clamp





Figure 6b: Current sense ratio²²:



²² This range for the current sense ratio refers to all devices. The accuracy of the $k_{\rm ILIS}$ can be raised by means of calibration the value of $k_{\rm ILIS}$ for every single device.



Figure 7a: Output voltage drop versus load current:





Package and Ordering Code

All dimensions in mm

SMD:TO-220-7-180

| Sales code | BTS6144B |
|---------------|-------------------|
| Ordering code | Q67060-S6058-A102 |



Standard (straight): TO220-7-230

| Sales code | BTS6144P |
|---------------|-------------------|
| Ordering code | Q67060-S6320-A102 |



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